Polymer

Wayon Electronics Co., Ltd.



PTC Devices LP-NSM150/8

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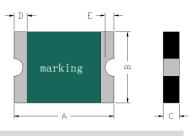
Surface Mount Thermistor E-mail: market@way-on.com

Http://www.way-on.com

Features

- Small size 1206, Normal working temperature with -40°C ~85°C
- Lead-free and compliant with the European Union RoHS Directive (EU)2015/863
- Fast tripping resettable circuit protection
- Surface mount packaging for automated assembly
- Agency Recognition: UL、TUV

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Product Dimension (mm)

Dart Number	Α	В	С	D	E	Part	
Part Number –	Max.	Max.	Max.	Min.	Min.	Marking	
LP-NSM150/8	3.50	1.80	1.30	0.25	0.10	Ν	

Electrical Characteristics

Part Number	Ін	Iτ	V _{max}	I _{max}	T _{trip}		Pd _{typ}	R _{min}	R _{1max}
	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	(Ω)	(Ω)
LP-NSM150/8	1.50	3.00	8	40	8.0	1.00	1.2	0.040	0.120

I_H=Hold current: maximum current at which the device will not trip at 25°C still air.

I_T=Trip current: minimum current at which the device will always trip at 25°C still air.

V_{max}=Maximum voltage device can withstand without damage at rated current.

I_{max}=Maximum fault current device can withstand without damage at rated voltage.

 T_{trip} =Maximum time to trip(s) at assigned current.

Pdtvp=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

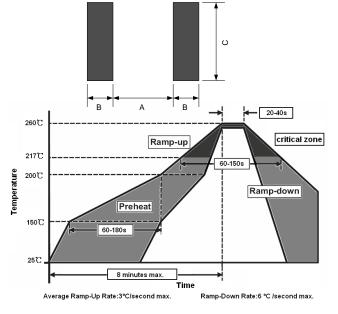
R_{min}=Minimum device resistance at 25°C prior to tripping.

R_{1max}=Maximum device resistance measured in the nontripped state 1 hour post reflow.

Thermal Derating

	Maximum ambient operating temperature(°C)									
LP-NSM150/8	-40	-20	0	20	25	40	50	60	70	85
Hold Current (A)	2.03	1.80	1.63	1.55	1.50	1.24	1.11	1.03	0.88	0.69
Trip Current (A)	4.06	3.60	3.26	3.10	3.00	2.48	2.22	2.06	1.76	1.38

Solder Reflow Recommendation



Solder Pad Lavout

	201401 1	aa 2a) * at		
Part Number	Α	В	С	
	(mm)	(mm)	(mm)	
LP-NSM150/8	1.80	1.00	1.80	

Recommended reflow methods: IR, vapor phase, hot air oven. Notes:

- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Devices are not designed to be wave soldered to the bottom side of the board.

Package Information

Tape & Reel: 4000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.

DOCUME REV LETT	NT: M20797			WAYON
PAGE NO	: 2 OF 2	Polymer	Wayon Electronics Co.,	
REV DATE: 2022-11-17 PART NUMBER:		PTC Devices	No.1001, Shiwan 7th Road, Pu	udong, Shanghai 201202, P.R.China
	M150/8	Surface Mount Thermistor	Tel: 86-21-50968308	Fax: 86-21-50968310 Http://www.way-on.com
			ND PTC 使用注意事	
4	建大地收书机		ions for SMD PTC	USE 最大电流规格值的操作,可能会导致 PTC 出现电
1.	请任规格书规 弧,阻值升高		用, 超出 PIC 取入电压以I	取入电弧沈裕值的操作,可能会寻到 PIC 出现电
	Operation be	ond the maximum voltage or	current may result in devic	e damage, PTC arcing, resistance increasing,
2.	even burning. 却枚土斫抑空		具 DTC 经过一次回流相按/	导出的常规性能,PTC 能够在不同温度对应的电
۷.		1小时。该电流并不是该型号		
	The Hold curr	ent specified at different temp	eratures in the datasheet is	s the conventional performance of after one
		g. PTC can hold 1 hour at the PTC can charging or discharg		ifferent temperatures. But this current is not the
3.				·次回流焊之后的测试。如果客户有二次回流焊或
		其他热工序, 会对上述参数有		
				eet are based on the test tested on the specified s to be verified because above parameters may
	be attenuated	l if customer has other proces	ses, like twice soldering or	injection.
4.				源元件,尽量减少外部热源的影响。
		itside heat source impact.	mended that no heat source	ce devices be designed to around in order to
5.	PTC 贴片产品	是为 SMT 工艺设计的封装形		接工艺可参考维安推荐的回流焊曲线。如果回流
	焊温度超过推 风枪。	荐的值,PTC 将有可能受到损	伤。禁止使用手工焊接 PT	C,禁止对线路板其他元件或端子返工时使用热
		designed for SMT technology,	and its reflow soldering. Pl	lease refer to the Wayon recommended
	soldering curv	ve. If the soldering temperature	e exceeds the recommend	ed value, the PTC might be damaged. Manual
0				ork of other components on the board.
6.				校粘剂、硅胶,需要对注塑料胶料等材料牌号以 :,确认不会影响 PTC 性能之后方可使用。
	When assem	bling and applying PTC, the m	aterial mark and applicatio	n parameters (Temperature, Time, and etc.) of
				Id be verified to ensure the consistency between would not influent PTC then can be used.
7.				1必须使用,需要验证各类清洗剂、洗板水以及溶
				响的化学药品包括但不仅限于醚类、苯类、酮类
	以及脂类等较 分的挥发。	强溶解性、破坏性的有机化合物	物。清洗后将产品放置于敞	(开的环境中至少24小时,将残留的溶剂进行充
		oling and applying PTC, it is n	ot recommended that using	g washer water or other cleaner to clean PTC. If
				er, washer water and solvents, it is also
				at are known to have an effect on PTC include, nds such as ethers, benzenes, ketones, and
	lipids. Placing	the product in open environm	nent for at least 24 hours to	volatilize the residual solvents.
8.		避免用暴力砸、挤、压、拉、 t smash, clamp, pull, dent, twis		本, 以免引起 PTC 性能衰减。 ssembling process to avoid the performance
	degradation.		C C	
9.		,PTC 焊接至保护板后,如需 闭保存,可避免 PTC 长时间缘		的时间内完成,如贴装与注塑打胶时间间隔超过1
				e injection or glue as soon as possible. IF the
			re than 1 month, PTC need	Is to reserve in the closed space so as to avoid
10.		o the air too long. [保护元件,但并不能当做开关	使用, 重复多次的保护会降	备低 PTC 的维持电流。
	PTC is resetta	able protector, which shall not	be used as switch. The ho	ld current will reduced after repeated tripping.
11.		端应用中,建议使用 PP 类材		
	are prohibited		PP material is recommend	led as inner membrane, TPE or PVC materials
12.	维安 SMD PT	C 湿敏等级为1级,为密封包	装。客户如在库存中发现有	包装破损的,立即将产品隔离处理;使用时如有
		之前包装状态,做密封保存。	aled packed. If any damag	ed package is found by customer, please isolate
	them. If there	is rest parts, needs repack it a	as the previous package ar	nd reserve hermetically.
13.	产品报废时,	可随着终端的产品,按照当地	的法律法规回收报废,具体	原材料组成可参见 MSDS。
		duct is finally discarded, it car compositions of PPTC can be		cordance with local laws and regulations, and